L	Hits	S arch Text	DB	Tim stamp
Numb r	670	titanium with (diffus\$5 n ar2 (b nd\$5	USPAT;	2003/03/20
1	670	w Id\$5))	US-PGPUB;	09:09
		W 1443))	EPO; JPO;	00.00
			DERWENT;	
			IBM_TDB	
	109	(titanium with (diffus\$5 near2 (bond\$5	USPAT;	2003/03/20
8	109	weld\$5))) and (groove channel) and (cut\$5	US-PGPUB:	08:49
		slic\$4)	EPO; JPO;	00.43
			DERWENT;	
			IBM_TDB	
	78	(titanium with (diffus\$5 near2 (bond\$5	USPAT;	2003/03/20
22	76	•	1	09:00
		weld\$5))) and ((228/157).CCLS.)	US-PGPUB;	09:00
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0003/03/00
15	218	(228/157).CCLS.	USPAT;	2003/03/20
			US-PGPUB;	09:09
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
29	11	(("5031483") or ("5204055") or ("5340656") or	USPAT;	2003/03/20
ĺ		("5387380") or ("5775402") or	US-PGPUB;	09:01
		("5855933")).PN.	EPO; JPO;	
			DERWENT;	
		,	IBM_TDB	
36	. 6	(("5031483") or ("5204055") or ("5340656") or	USPAT	2003/03/20
		("5387380") or ("5775402") or		09:01
		("5855933")).PN.		
37	0	((("5031483") or ("5204055") or ("5340656") or	USPAT;	2003/03/20
		("5387380") or ("5775402") or	US-PGPUB;	09:02
		("5855933")).PN.) and (diffus\$5 near2 (bond\$5	EPO; JPO;	
		weld\$5))	DERWENT;	
			IBM_TDB	
44	20	grind\$5 same polish\$5 same (diffus\$5 near2	USPAT;	2003/03/20
		(bond\$5 weld\$5))	US-PGPUB;	09:11
			EPO; JPO;	
			DERWENT;	•
			IBM_TDB	
51	1	grind\$5 same polish\$5 same (diffus\$5 near2	USPAT;	2003/03/20
		(bond\$5 weld\$5)) same titanium	US-PGPUB;	09:12
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
58	0	(demray).in. and (diffus\$5 near2 bond\$5)	USPAT;	2003/03/20
			US-PGPUB;	09:12
İ			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

				
65	15	(d maray).in. and (diffus\$5 near2 b nd\$5)	USPAT;	2003/03/20
			US-PGPUB;	09:13
			EPO; JP ;	
			DERWENT;	
			IBM_TDB	
72	1	((d maray).in. and (diffus\$5 near2 bond\$5))	USPAT;	2003/03/20
		and (grind\$5 same polish\$5)	US-PGPUB;	09:13
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	1655	((228/119) or (228/141.1) or (228/193) or	USPAT;	2003/03/20
		(228/195) or (29/592+) or (29/700+)).CCLS.	US-PGPUB;	08:35
		(220.100) 60 (20.002) 61 (20.000)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	166355	(29/\$).ccis.	USPAT;	2003/03/18
•	100333	(23/4).0013.	US-PGPUB;	16:34
			EPO; JPO;	
			DERWENT;	
	1	(((000)440) (000)4400)	IBM_TDB	2003/03/18
•	987	((((228/119) or (228/141.1) or (228/193) or	USPAT;	
		(228/195) or (29/592+) or (29/700+)).CCLS.)	US-PGPUB;	16:34
		((29/\$).ccls.)) and (diffus\$5 near2 bond\$5)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	546	steel with (diffus\$5 near2 bond\$5)	USPAT;	2003/03/18
			US-PGPUB;	16:35
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	81	(((((228/119) or (228/141.1) or (228/193) or	USPAT;	2003/03/18
		(228/195) or (29/592+) or (29/700+)).CCLS.)	US-PGPUB;	16:35
		((29/\$).ccls.)) and (diffus\$5 near2 bond\$5))	EPO; JPO;	
		and (steel with (diffus\$5 near2 bond\$5))	DERWENT;	
		, , , , , , , , , , , , , , , , , , , ,	IBM_TDB	
_	189	tool\$6 with (diffus\$5 near2 bond\$5)	USPAT;	2003/03/18
			US-PGPUB;	19:32
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	175	mold\$6 with (diffus\$5 near2 bond\$5)	USPAT;	2003/03/18
•	1/5	ווויישעט אינוו (עווושטעט וופמוב טטוועעט)	US-PGPUB;	16:38
			EPO; JPO;	
			DERWENT;	
	4-	(4. 100 14). (JUE 00 0 100).	IBM_TDB	2002/02/49
•	10	(tool\$6 with (diffus\$5 near2 bond\$5)) and	USPAT;	2003/03/18
		(mold\$6 with (diffus\$5 near2 bond\$5))	US-PGPUB;	17:09
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

-	41	(j seph with bak).in. (neil with baldwin).in. (james with beals).in. (zissis with dardas).in. (wayde with schmidt).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/18 16:41
-	2	((j s ph with bak).in. (n il with baldwin).in. (james with beals).in. (zissis with dardas).in. (wayde with schmidt).in.) and (diffus\$5 near2	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/03/18 16:42
_	1	bond\$5) ("5849238").PN.	DERWENT; IBM_TDB USPAT	2003/03/18
-	1	("5031483").PN.	USPAT	18:17 2003/03/18
-				18:17
	65	(((((228/119) or (228/141.1) or (228/193) or (228/195) or (29/592+) or (29/700+)).CCLS.) ((29/\$).ccls.)) and (diffus\$5 near2 bond\$5)) and (tool\$6 with (diffus\$5 near2 bond\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/18 19:32
•	1	steel same carbon same silicon same manganese same molybedenum same vanadium	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:38
-	676	(s7 a2 m2 w2 h13 d2 d3) near2 steel	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/19 21:39
-	13201	beryllium with copper	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/03/19 21:41
-	355728	titanium	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:39
-	1092	(((s7 a2 m2 w2 h13 d2 d3) near2 steel) (beryllium with copper) titanium) same (diffus\$5 near2 (bond\$5 weld\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 22:07
-	10164	beryllium near2 copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:41
-	697	(((s7 a2 m2 w2 h13 d2 d3) near2 st l) (b ryllium with copper) titanium) with (diffus\$5 near2 (b nd\$5 weld\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/19 21:41

•	685	(((s7 a2 m2 w2 h13 d2 d3) near2 st l) (beryllium n ar2 copper) titanium) with	USPAT; US-PGPUB;	2003/03/19 21:42
		(diffus\$5 near2 (b nd\$5 w ld\$5))	EPO; JP ; DERWENT; IBM TDB	
-	454	(((s7 a2 m2 w2 h13 d2 d3) n ar2 steel)	USPAT	2003/03/19
		(beryllium near2 copper) titanium) with (diffus\$5 near2 (bond\$5 weld\$5))		21:45
-	27	((((s7 a2 m2 w2 h13 d2 d3) near2 steel)	USPAT;	2003/03/19
		(beryllium near2 copper) titanium) with	US-PGPUB;	22:06
		(diffus\$5 near2 (bond\$5 weld\$5))) same mold\$6	EPO; JPO; DERWENT;	
		moida	IBM_TDB	
-	20	grind\$5 same polish\$5 same (diffus\$5 near2	USPAT;	2003/03/19
		(bond\$5 weld\$5))	US-PGPUB;	22:08
			EPO; JPO;	
			DERWENT;	